DATA SHEET



HIGH PERFORMANCE HP SERIES RF DATA MODULES

TXM-900-HP3 RXM-900-HP3

FEATURES

- Complete 900 Mhz RF TX/RX solution No external components (except antenna) or user tuning required.
- Up to 120 selectable channels Parallel or serial channel selection options.
- High data rate 50,000 bps max. data rate
- Outstanding range 1000 ft. maximum range. (Line of Sight)
- Qualified data output, True RSSI, CTS functions Allows for channel qualification and assures data validity.
- Wide range analog data capability Analog capability for audio or frequency transmission
- Microprocessor-based synthesized architecture Advanced microprocessor managed synthesized design.
- Direct interface Logic level serial I/O. Interface directly to microprocessors, UART's, encoder/decoder chips.
- Cost-effective Lowest cost to performance ratio of any available device.

DESCRIPTION

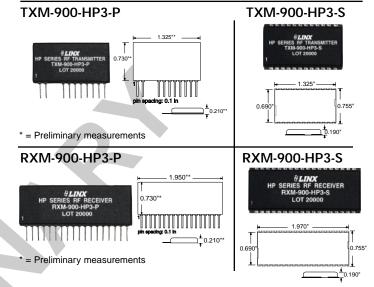
Designed for cost-effective, high-performance wireless transfer of analog or serial digital data, the HP-Series offers multiple user selectable channels in the popular 902-928MHz band. In the US this band is ideal for a wide variety of wireless applications. To assure reliable performance, the modules employ FM/FSK modulation and an advanced microprocessor-controlled synthesized architecture. For digital applications the HP-series can be directly interfaced with any microcontroller, encoder/decoder, or UART for serial data transfer at rates to 50Kbps. The modules are also capable of transmitting analog information such as voice or analog frequencies within a 50Hz-25Khz range. Other features include CTS, RSSI, and power-down functions. Like all Linx modules, the HP-Series requires no tuning or external components (except an antenna).

SPECIFICATIONS

TXM-900-HP3

Parameter	Min.	Typical	Max.	Units			
Modulation Method	Frequency Shift Keying FSK (Digital) Frequency Modulation FM (Analog)						
Transmission Frequencies	902 – 928			MHz			
hannels 8 Parallel/120 Serially Selectable Channels							
Supply voltage	2.7	-	13	VDC			
Supply current		15	17	mA			
Output power into 50Ω	-3	0	+4	dBm			
Overall frequency accuracy	±50KHz						
Data input low	0		0.4	volts			
Data input high	2.7		5	volts			
Operating temp. range		TBD		°C			
Analog frequency range	50 Hz - 25 KHz						
Data rate	300-50,000 Bits/Sec						
Antenna	50Ω 1/4-Wave						
Package	SIP or SMD Style						

PACKAGE OUTLINES



ORDERING INFORMATION

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Ĭ	PART #	DESCRIPTION
	MDEV-900-HP3	HP3 Development Kit
	TXM-900-HP3-PPO	Transmitter Pinned SIP Package - 8 Parallel Ch. Sel.
	TXM-900-HP3-PPS	Transmitter Pinned SIP Package - 8 Parallel/120 Serial Ch. Sel.
	TXM-900-HP3-SPO	Transmitter SMD Package - 8 Parallel Ch. Sel.
	TXM-900-HP3-SPS	Transmitter SMD Package - 8 Parallel/120 Serial Ch. Sel.
	RXM-900-HP3-PPO	Receiver - Pinned SIP Package - 8 Parallel Ch. Sel.

RXM-900-HP3-PPS Receiver - Pinned SIP Package - 8 Parallel/120 Serial Ch. Sel. RXM-900-HP3-SPO Receiver - SMD Package - 8 Parallel Ch. Sel.

RXM-900-HP3-SPS Receiver - SMD Package - 8 Parallel/120 Serial Ch. Sel.

APPLICATIONS

Ideally suited to a variety of wireless applications including:

- Wireless Data Transfer
- **Process Monitoring**
- Home/Industrial Automation
- **Keyless Entry**
- Remote Control
- Fire/Security Alarms
- Wireless Networks
- Remote Status/ Position Sensing
- Telemetry
- RS-232/485 Data Links

RXM-900-HP3

Parameter		Min.	Typical	Max.	Units		
Receiver type	Synthesized Double Conversion Superhet						
Reception Frequencies			MHz				
Channels	8 I	Parallel/120 Serially Selectable Channels					
Supply voltage		2.7	-	13	VDC		
Supply current		16	18	20	mA		
Sensitivity		-92	-97	-100	dBm		
Max. RF input				0	dBm		
Data output low		0.0		0.5	volts		
Data output high		V _{CC} 7		V_{CC}	volts		
Operating temp. range			TBD		°C		
Analog frequency range		50 Hz - 25 KHz					
Data rate		300-50,000 Bits/Sec					
Antenna		50Ω 1/4-Wave					
Package		SIP or SMD Style					

This data sheet contains information of a preliminary nature. Recipient understands any or all of the above specifications are subject to change without notice and proceeds with integration at own risk.